General Purpose Transistor

PNP Silicon

Features

 These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector - Emitter Voltage	V _{CEO}	-40	Vdc
Collector - Base Voltage	V _{CBO}	-40	Vdc
Emitter - Base Voltage	V _{EBO}	-5.0	Vdc
Collector Current - Continuous	I _C	-200	mAdc
Collector Current - Peak (Note 3)	I _{CM}	-800	mAdc

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board (Note 1) @ T _A = 25°C Derate above 25°C	P _D	225 1.8	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	556	°C/W
Total Device Dissipation Alumina Substrate, (Note 2) @ T _A = 25°C Derate above 25°C	P _D	300 2.4	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	417	°C/W
Junction and Storage Temperature	T _J , T _{stg}	-55 to +150	°C

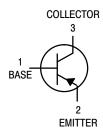
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. FR-5 = $1.0 \times 0.75 \times 0.062$ in.
- 2. Alumina = $0.4 \times 0.3 \times 0.024$ in. 99.5% alumina.
- 3. Reference SOA curve.



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SOT-23 (TO-236) CASE 318 STYLE 6

MARKING DIAGRAM



2A = Specific Device Code

M = Date Code*

= Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

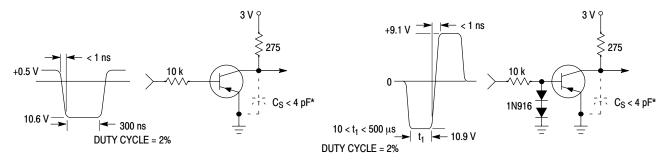
Device	Package	Shipping [†]
MMBT3906LT1H	SOT-23 (Pb-Free)	3,000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Charac	Symbol	Min	Max	Unit		
OFF CHARACTERISTICS						
Collector – Emitter Breakdown Voltage (I _C = -1.0 mAdc, I _B = 0)	V _{(BR)CEO}	-40	_	Vdc		
Collector – Base Breakdown Voltage ($I_C = -10 \mu Adc, I_E = 0$)	V _{(BR)CBO}	-40	_	Vdc		
Emitter – Base Breakdown Voltage ($I_E = -10 \mu Adc, I_C = 0$)		V _{(BR)EBO}	-5.0	_	Vdc	
Base Cutoff Current ($V_{CE} = -30 \text{ Vdc}$, $V_{EB} = -3.0 \text{ Vdc}$)		I _{BL}	-	-50	nAdc	
Collector Cutoff Current (V _{CE} = -30 Vdc, V _{EB} = -3.0 Vdc)	I _{CEX}	-	-50	nAdc		
ON CHARACTERISTICS (Note 4)		•				
$\begin{array}{c} \text{DC Current Gain} \\ \text{(I}_{\text{C}} = -0.1 \text{ mAdc, V}_{\text{CE}} = -1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = -1.0 \text{ mAdc, V}_{\text{CE}} = -1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = -10 \text{ mAdc, V}_{\text{CE}} = -1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = -50 \text{ mAdc, V}_{\text{CE}} = -1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = -100 \text{ mAdc, V}_{\text{CE}} = -1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = -100 \text{ mAdc, V}_{\text{CE}} = -1.0 \text{ Vdc)} \end{array}$		H _{FE}	60 80 100 60 30	- 300 - -	-	
Collector – Emitter Saturation Voltage ($I_C = -10 \text{ mAdc}$, $I_B = -1.0 \text{ mAdc}$) ($I_C = -50 \text{ mAdc}$, $I_B = -5.0 \text{ mAdc}$)	V _{CE(sat)}	_ _	-0.25 -0.4	Vdc		
Base – Emitter Saturation Voltage $ \begin{pmatrix} I_C = -10 \text{ mAdc}, I_B = -1.0 \text{ mAdc} \\ I_C = -50 \text{ mAdc}, I_B = -5.0 \text{ mAdc} \end{pmatrix} $	V _{BE(sat)}	-0.65 -	-0.85 -0.95	Vdc		
SMALL-SIGNAL CHARACTERISTICS		•				
Current – Gain – Bandwidth Product $(I_C = -10 \text{ mAdc}, V_{CE} = -20 \text{ Vdc}, f)$	= 100 MHz)	f _T	250	_	MHz	
Output Capacitance (V _{CB} = -5.0 Vdc, I _E = 0, f = 1.0 M	Hz)	C _{obo}	-	4.5	pF	
Input Capacitance (V _{EB} = -0.5 Vdc, I _C = 0, f = 1.0 M	Hz)	C _{ibo}	-	10	pF	
Input Impedance (I _C = -1.0 mAdc, V _{CE} = -10 Vdc, f = 1.0 kHz)			2.0	12	kΩ	
Voltage Feedback Ratio $(I_C = -1.0 \text{ mAdc}, V_{CE} = -10 \text{ Vdc}, f = 1.0 \text{ kHz})$			0.1	10	X 10 ⁻⁴	
Small – Signal Current Gain (I _C = -1.0 mAdc, V _{CE} = -10 Vdc, f = 1.0 kHz)			100	400	-	
Output Admittance ($I_C = -1.0 \text{ mAdc}$, $V_{CE} = -10 \text{ Vdc}$, $f = 1.0 \text{ kHz}$)			3.0	60	μmhos	
Noise Figure (I _C = $-100 \mu Adc$, V _{CE} = $-5.0 Vdc$,	NF	-	4.0	dB		
SWITCHING CHARACTERISTICS						
Delay Time	(V _{CC} = -3.0 Vdc, V _{BE} = 0.5 Vdc,		_	35	m-	
Rise Time	$I_C = -10 \text{ mAdc}, I_{B1} = -1.0 \text{ mAdc})$	t _r	-	35	ns	
Storage Time	$(V_{CC} = -3.0 \text{ Vdc}, I_{C} = -10 \text{ mAdc},$	t _s	_	225	ns	
Fall Time	$I_{B1} = I_{B2} = -1.0 \text{ mAdc}$	t _f	-	75	113	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.



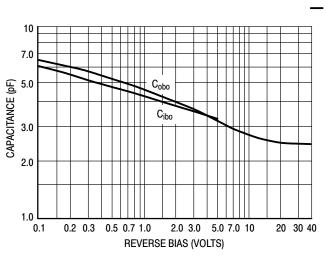
* Total shunt capacitance of test jig and connectors

Figure 1. Delay and Rise Time Equivalent Test Circuit

Figure 2. Storage and Fall Time Equivalent Test Circuit

TYPICAL TRANSIENT CHARACTERISTICS

- T_J = 25°C





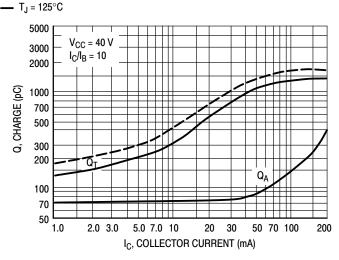


Figure 4. Charge Data

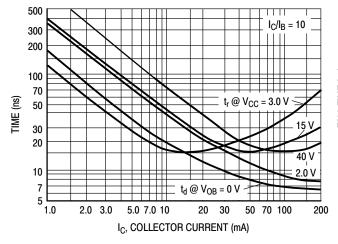


Figure 5. Turn - On Time

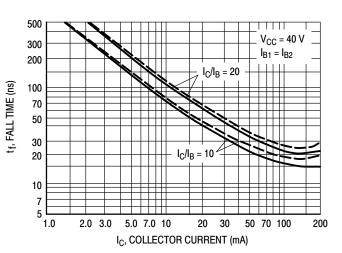
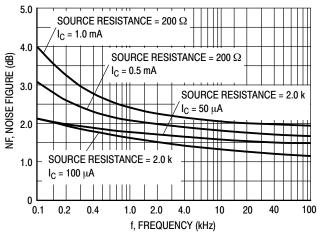


Figure 6. Fall Time

TYPICAL AUDIO SMALL-SIGNAL CHARACTERISTICS NOISE FIGURE VARIATIONS

 $(V_{CE} = -5.0 \text{ Vdc}, T_A = 25^{\circ}\text{C}, Bandwidth = 1.0 \text{ Hz})$



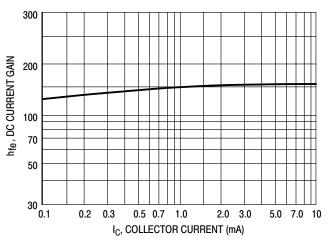
f = 1.0 kHz10 NF, NOISE FIGURE (dB) 8 6 4 $I_C = 50 \mu A$ $I_C = 100 \mu A$ 0.2 0.4 40 100 2.0 0.1 1.0 4.0 R_g, SOURCE RESISTANCE (k OHMS)

Figure 7.

Figure 8.

h PARAMETERS

 $(V_{CE} = -10 \text{ Vdc}, f = 1.0 \text{ kHz}, T_A = 25^{\circ}\text{C})$



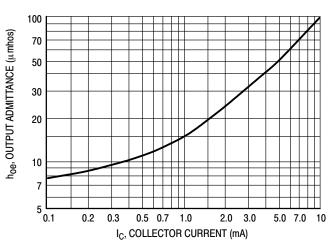
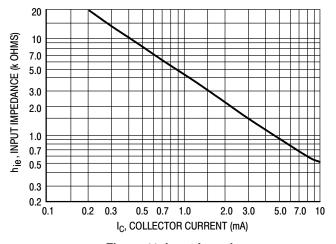


Figure 9. Current Gain

Figure 10. Output Admittance



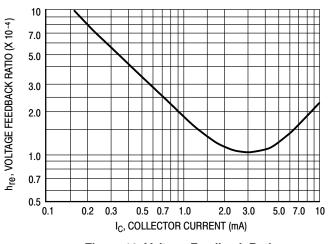


Figure 11. Input Impedance

Figure 12. Voltage Feedback Ratio

TYPICAL STATIC CHARACTERISTICS

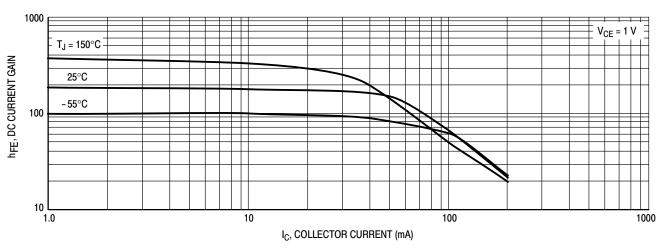


Figure 13. DC Current Gain

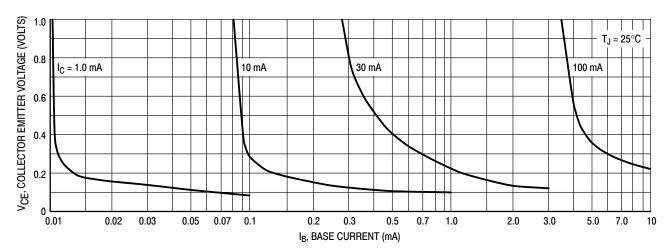


Figure 14. Collector Saturation Region

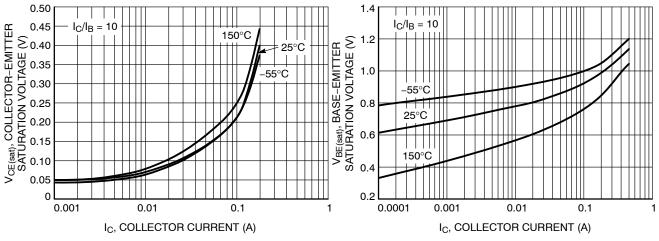


Figure 15. Collector Emitter Saturation Voltage vs. Collector Current

Figure 16. Base Emitter Saturation Voltage vs. **Collector Current**

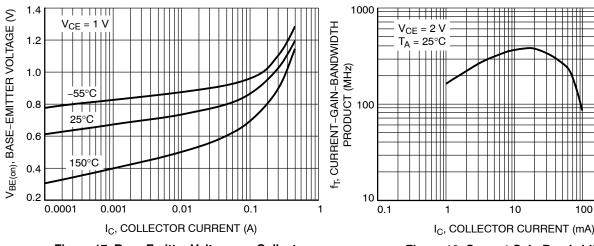


Figure 17. Base Emitter Voltage vs. Collector Current

Figure 18. Current Gain Bandwidth vs. **Collector Current**

10

100

1000

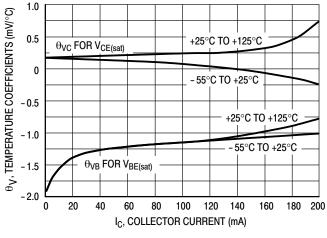


Figure 19. Temperature Coefficients

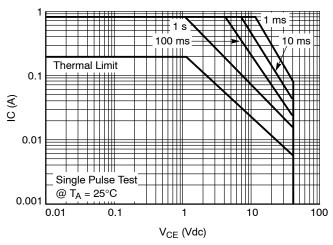
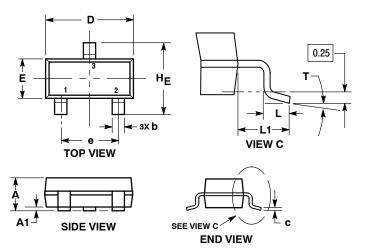


Figure 20. Safe Operating Area

PACKAGE DIMENSIONS

SOT-23 (TO-236)

CASE 318-08 **ISSUE AR**



NOTES:

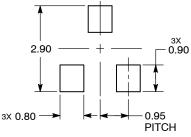
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS.
 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH.
- MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	MILLIMETERS			INCHES		
DIN	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.039	0.044
A1	0.01	0.06	0.10	0.000	0.002	0.004
b	0.37	0.44	0.50	0.015	0.017	0.020
С	0.08	0.14	0.20	0.003	0.006	0.008
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.080
L	0.30	0.43	0.55	0.012	0.017	0.022
L1	0.35	0.54	0.69	0.014	0.021	0.027
HE	2.10	2.40	2.64	0.083	0.094	0.104
Т	O°		10 °	0 °		10 °

STYLE 6:

- PIN 1. BASE
 - **EMITTER**
 - COLLECTOR

RECOMMENDED **SOLDERING FOOTPRINT***



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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